

Product Specifications

Product Name		Aluminum Copper Silicon (AlSiCu) Sputtering Target
Chemical formula		AlSiCu
CAS Number		N.A.
QSAM supplier item code		DPSI1329ST
Product type		Alloy
Purity range		0.999
Diameter	Min.	0.5"
	Max.	14"
Relative density		4 weeks
Boiling point		N.A.
Melting point		N.A.
Appearance		Grey metal, no odor
Backing plate and bonding		Cu or Mo backing plate with indium bonding
Typical lead time		4 weeks